Thyristor

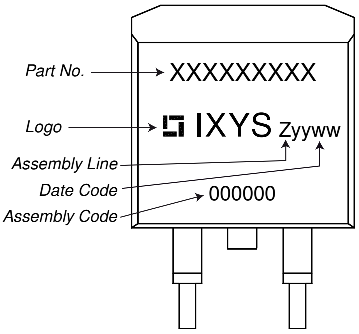
Symbol	Definition	Conditions		Ratings min.	Ratings typ.	Ratings max.	Unit
$V_{RSM/DSM}$	*max. non-repetitive reverse/forward blocking voltage*		T_{VJ} = 25°C			1300	V
$V_{RRM/DRM}$	*max. repetitive reverse/forward blocking voltage*		T_{VJ} = 25°C			1200	V
$I_{R/D}$	*reverse current, drain current*	$V_{R/D}$ = 1200 V	T_{VJ} = 25°C			50	µA
		$V_{R/D}$ = 1200 V	T_{VJ} = 125°C			1	mA
V_T	*forward voltage drop*	I_T = 20 A	T_{VJ} = 25°C			1.32	V
		I_T = 40 A				1.65	V
		I_T = 20 A	T_{VJ} = 125°C			1.31	V
		I_T = 40 A				1.73	V
I_{TAV}	*average forward current*	T_C = 110°C	T_{VJ} = 125°C			20	A
$I_{T(RMS)}$	*RMS forward current*	180° sine				31	A
V_{T0}	*threshold voltage*	*for power loss calculation only*	T_{VJ} = 125°C			0.86	V
r_T	*slope resistance*					22	mΩ
R_{thJC}	*thermal resistance junction to case*					0.7	K/W
R_{thCH}	*thermal resistance case to heatsink*				0.50		K/W
P_{tot}	*total power dissipation*		T_C = 25°C			170	W
I_{TSM}	*max. forward surge current*	t = 10 ms; (50 Hz), sine	T_{VJ} = 45°C			180	A
		t = 8,3 ms; (60 Hz), sine	V_R = 0 V			195	A
		t = 10 ms; (50 Hz), sine	T_{VJ} = 125°C			155	A
		t = 8,3 ms; (60 Hz), sine	V_R = 0 V			165	A
I^2t	*value for fusing*	t = 10 ms; (50 Hz), sine	T_{VJ} = 45°C			160	A^2s
		t = 8,3 ms; (60 Hz), sine	V_R = 0 V			160	A^2s
		t = 10 ms; (50 Hz), sine	T_{VJ} = 125°C			120	A^2s
		t = 8,3 ms; (60 Hz), sine	V_R = 0 V			115	A^2s
C_J	*junction capacitance*	V_R = 230 V f = 1 MHz	T_{VJ} = 25°C		9		pF
P_{GM}	*max. gate power dissipation*	t_P = 30 µs	T_C = 125°C			5	W
		t_P = 300 µs				2.5	W
P_{GAV}	*average gate power dissipation*					0.5	W
$(di/dt)_{cr}$	*critical rate of rise of current*	T_{VJ} = 150 °C; f = 50 Hz	repetitive, I_T = 60 A			150	A/µs
		t_P = 200 µs; di_G/dt = 0.15 A/µs;					
		I_G = 0.15 A; V = ⅔ V_{DRM}	non-repet., I_T = 20 A			500	A/µs
$(dv/dt)_{cr}$	*critical rate of rise of voltage*	V = ⅔ V_{DRM}	T_{VJ} = 150°C			500	V/µs
		R_{GK} = ∞; method 1 (linear voltage rise)					
V_{GT}	*gate trigger voltage*	V_D = 6 V	T_{VJ} = 25°C			1.5	V
			T_{VJ} = -40°C			2.5	V
I_{GT}	*gate trigger current*	V_D = 6 V	T_{VJ} = 25°C			28	mA
			T_{VJ} = -40°C			50	mA
V_{GD}	*gate non-trigger voltage*	V_D = ⅔ V_{DRM}	T_{VJ} = 150°C			0.2	V
I_{GD}	*gate non-trigger current*					3	mA
I_L	*latching current*	t_p = 10 µs	T_{VJ} = 25°C			75	mA
		I_G = 0.1 A; di_G/dt = 0.1 A/µs					
I_H	*holding current*	V_D = 6 V R_{GK} = ∞	T_{VJ} = 25°C			50	mA
t_{gd}	*gate controlled delay time*	V_D = ½ V_{DRM}	T_{VJ} = 25°C			2	µs
		I_G = 0.1 A; di_G/dt = 0.1 A/µs					
t_q	*turn-off time*	V_R = 100 V; I_T = 20 A; V = ⅔ V_{DRM}	T_{VJ} = 100 °C		150		µs
		di/dt = 10 A/µs dv/dt = 20 V/µs	t_p = 200 µs				

Data according to IEC 60747and per semiconductor unless otherwise specified

Package TO-263 (D2Pak)

Symbol	Definition	Conditions	Ratings min.	typ.	max.	Unit
I_{RMS}	*RMS current*	per terminal			35	A
T_{VJ}	*virtual junction temperature*		-40		125	°C
T_{op}	*operation temperature*		-40		100	°C
T_{stg}	*storage temperature*		-40		150	°C
Weight				2		g
F_C	*mounting force with clip*		20		60	N

Product Marking

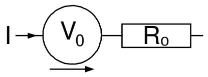


Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	CS19-12ho1S	CS19-12ho1S	Tape & Reel	800	501313
Alternative	CS19-12ho1S-TUB	CS19-12ho1S	Tube	50	473340

Similar Part	Package	Voltage class
CS19-12ho1	TO-220AB (3)	1200
CS19-08ho1	TO-220AB (3)	800
CS19-08ho1S	TO-263AB (D2Pak) (2)	800

Equivalent Circuits for Simulation

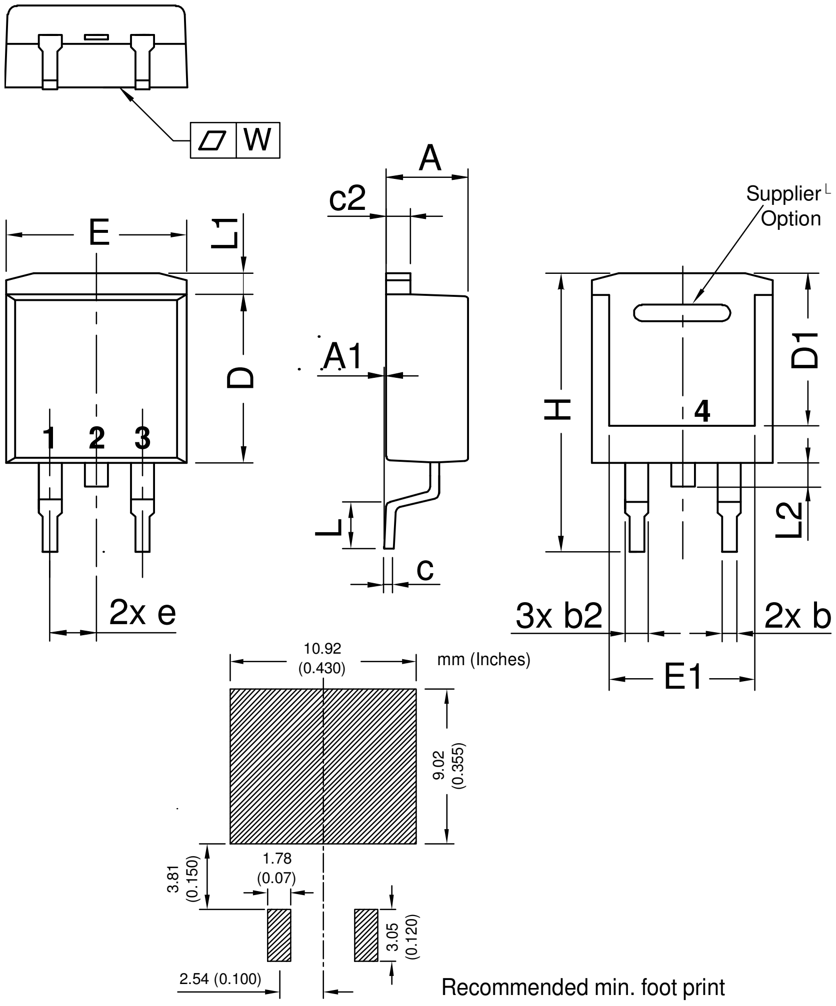
** on die level* $T_{VJ} = 125\,°C$



		Thyristor	
$V_{0\,max}$	*threshold voltage*	0.86	V
$R_{0\,max}$	*slope resistance **	19	mΩ

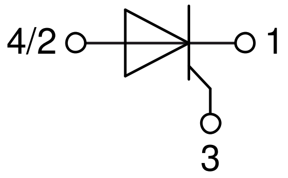
Data according to IEC 60747and per semiconductor unless otherwise specified

Outlines TO-263 (D2Pak)



Dim.	Millimeter		Inches	
	min	max	min	max
A	4.06	4.83	0.160	0.190
A1	typ. 0.10		typ. 0.004	
A2	2.41		0.095	
b	0.51	0.99	0.020	0.039
b2	1.14	1.40	0.045	0.055
c	0.40	0.74	0.016	0.029
c2	1.14	1.40	0.045	0.055
D	8.38	9.40	0.330	0.370
D1	8.00	8.89	0.315	0.350
D2	2.5		0.098	
E	9.65	10.41	0.380	0.410
E1	6.22	8.50	0.245	0.335
e	2,54 BSC		0,100 BSC	
e1	4.28		0.169	
H	14.61	15.88	0.575	0.625
L	1.78	2.79	0.070	0.110
L1	1.02	1.68	0.040	0.066
W	typ. 0.02	0.040	typ. 0.0008	0.002

All dimensions conform with and/or within JEDEC standard.



Thyristor

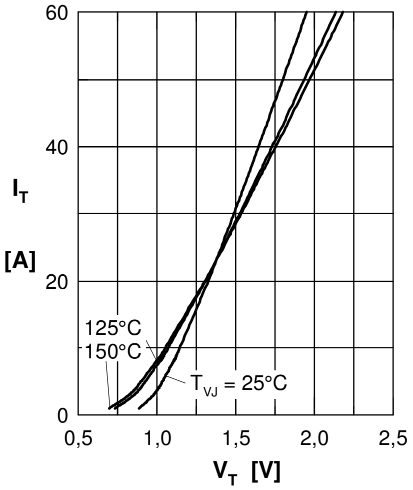


Fig. 1 Forward characteristics

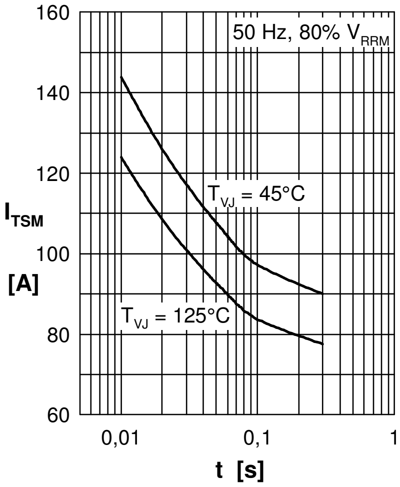


Fig. 2 Surge overload current

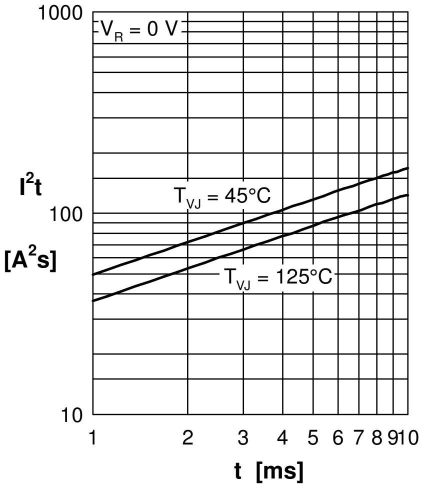


Fig. 3 I^2t versus time (1-10 ms)

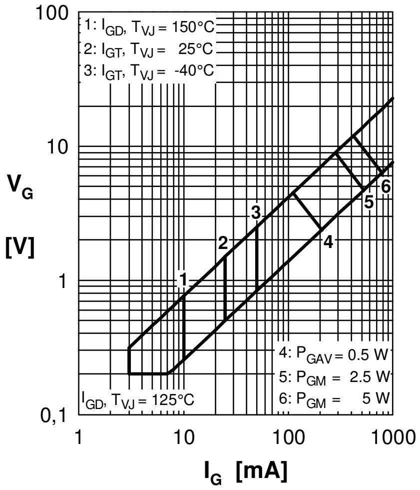


Fig. 4 Gate trigger characteristics

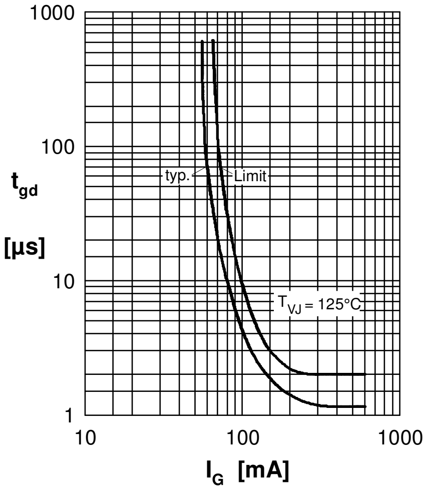


Fig. 5 Gate controlled delay time

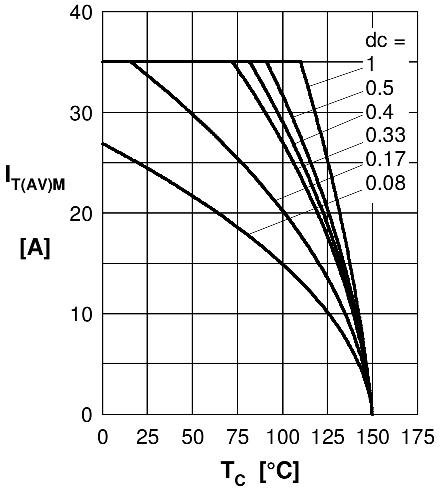


Fig. 6 Max. forward current at case temperature

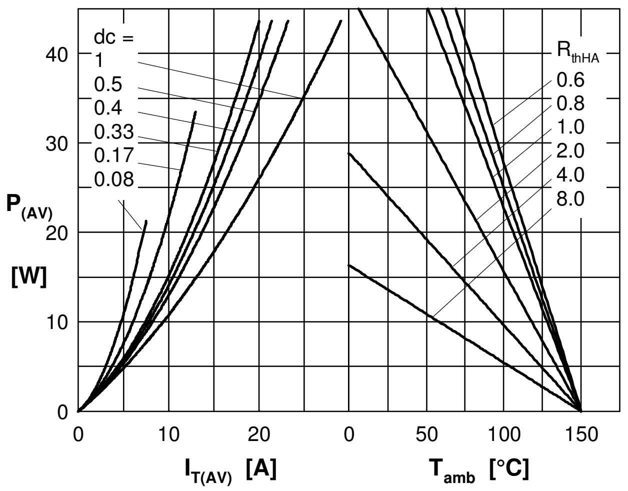
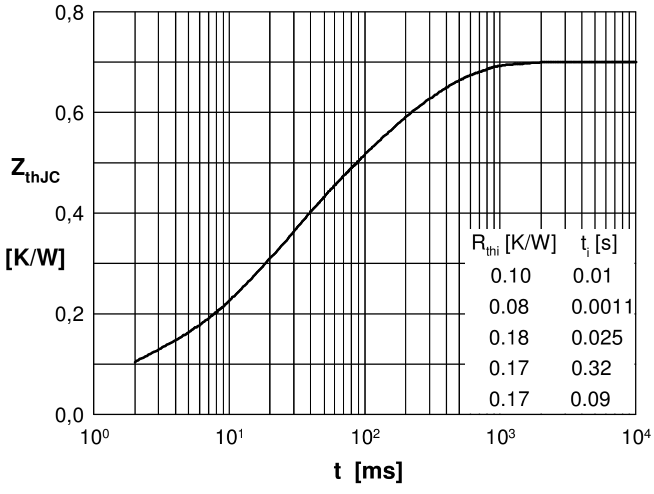


Fig. 7a Power dissipation versus direct output current
Fig. 7b and ambient temperature



R_{thi} [K/W]	t_i [s]
0.10	0.01
0.08	0.0011
0.18	0.025
0.17	0.32
0.17	0.09

Fig. 8 Transient thermal impedance junction to case